

Part Number: XZFBB79W

3.8x2.0mm DOME LENS SMD CHIP LED LAMP

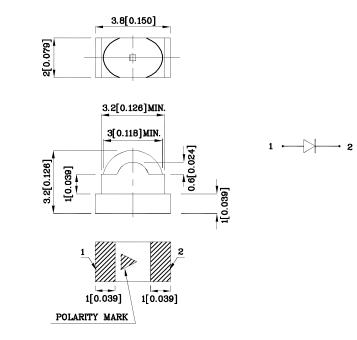
Features

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- Package : 500pcs / reel
- Moisture sensitivity level : level 3
- RoHS compliant





Package Schematics



Notes: 1. All dimensions are in millimeters (inches).

2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.

3. Specifications are subject to change without notice.

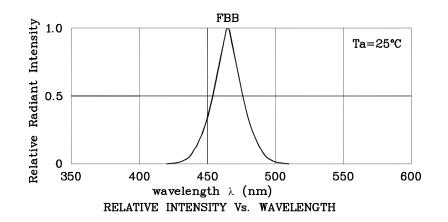
| Absolute Maximum Ratings (T _A =25°C) | FBB (InGaN) | Unit | | | |
|--|---------------------------|----------------|----|--|--|
| Reverse Voltage | V_{R} | 5 V | | | |
| Forward Current | \mathbf{I}_{F} | 30 | mA | | |
| Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width | ifs | 100 | mA | | |
| Power Dissipation | \mathbf{P}_{D} | 120 | mW | | |
| Electrostatic Discharge Threshold (HBM) | 250 | V | | | |
| Operating Temperature | $T_{\rm A}$ | $-40 \sim +85$ | °C | | |
| Storage Temperature | Tstg | -40 ~ +85 | U | | |

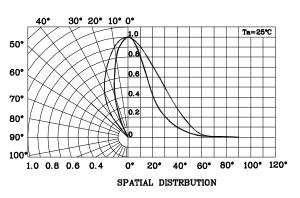
| Operating Characteristics (T _A =25°C) | | FBB (InGaN) | Unit |
|--|-------------------|----------------|-------------|
| Forward Voltage (Typ.) (I _F =20mA) | V_{F} | 3.3 | V |
| Forward Voltage (Max.) (I _F =20mA) | V_{F} | 4 | V |
| Reverse Current (Max.) (V _R =5V) | I_R | 50 | uA |
| Wavelength of Peak Emission (Typ.) (I _F =20mA) | λP | 465 | nm |
| Wavelength of Dominant Emission (Typ.) (I _F =20mA) | λD | 470 | nm |
| Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA) | $	riangle\lambda$ | 22 | nm |
| Capacitance (Typ.) (V _F =0V, f=1MHz) | С | 100 | $_{\rm pF}$ |

| Part Number | Emitting Color | Emitting Material | Lens-color | Lumi Inter (I _F =2 m | 0mÅ) | Wavelength nm λP | Viewing Angle 20 1/2 |
|----------------|-------------------|----------------------|-------------|--|------|------------------------|----------------------------|
| | | | | min. | typ. | | |
| XZFBB79W | Blue | InGaN | Water Clear | 600 | 795 | 465 | 60(H) 35(V) |
| | | | | | | | |

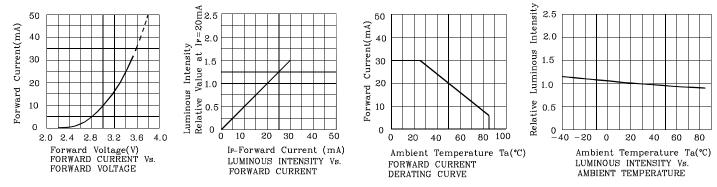
XDSB5694 V1 Layout: Maggie L.

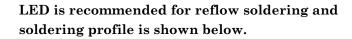




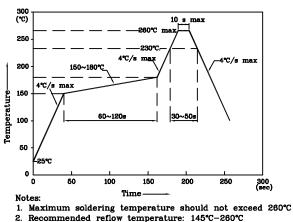


FBB





Reflow Soldering Profile for SMD Products (Pb-Free Components)



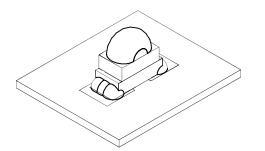
Recommended reflow temperature: 145°C-260°C Do not put stress to the epoxy resin during

З. high temperatures conditions

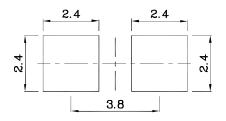
P. 2/4



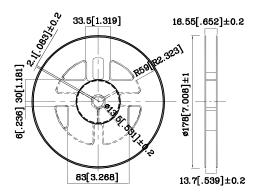
✤ The device has a single mounting surface. The device must be mounted according to the specifications.



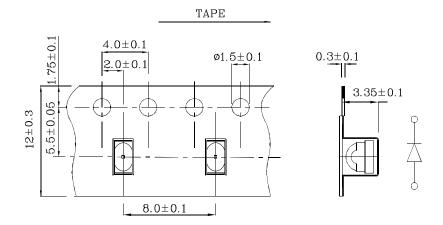
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V $\,$

Note: Accuracy may depend on the sorting parameters.

Apr 15,2011



PACKING & LABEL SPECIFICATIONS

